

INTERNATIONAL IEEE Std 1685™-2009 STANDARD

IP-XACT, Standard Structure for Packaging, Integrating, and Reusing IP within
Tool Flows

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IP-XACT, STANDARD STRUCTURE FOR PACKAGING, INTEGRATING, AND REUSING IP WITHIN TOOL FLOWS

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IEEE Std	FDIS	Report on voting
1685 (2009)	91/1207/FDIS	91/1226/RVD

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IP-XACT 1.2 and IP-XACT 1.5

Abstract: Conformance checks for eXtensible Markup Language (XML) data designed to describe electronic systems are formulated by this standard. The meta-data forms that are standardized include: components, systems, bus interfaces and connections, abstractions of those buses, and details of the components including address maps, register and field descriptions, and file set descriptions for use in automating design, verification, documentation, and use flows for electronic systems. A set of XML schemas of the form described by the World Wide Web Consortium (W3C®) and a set of semantic consistency rules (SCRs) are included. A generator interface that is portable across tool environments is provided. The specified combination of methodology-independent meta-data and the tool-independent mechanism for accessing that data provides for portability of design data, design methodologies, and environment implementations.

Keywords: abstraction definitions, address space specification, bus definitions, design environment, EDA, electronic design automation, electronic system level, ESL, implementation constraints, IP-XACT, register transfer level, RTL, SCRs, semantic consistency rules, TGI, tight generator interface, tool and data interoperability, use models, XML design meta-data, XML schema

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1999 Introduction

This introduction is not part of IEEE Std 1685-2009, IEEE Standard for IP-XACT, Standard Structure for Packaging, Integrating, and Reusing IP within Tool Flows.

The purpose of this standard is to provide the electronic design automation (EDA), semiconductor, electronic design intellectual property (IP) provider, and system design communities with a well-defined and unified specification for the meta-data that represents the components and designs within an electronic system. The goal of this specification is to enable delivery of compatible IP descriptions from multiple IP vendors; better enable importing and exporting complex IP bundles to, from, and between EDA tools for system on chip (SoC) design environments (DEs); better express configurable IP by using IP meta-data; and better enable provision of EDA vendor-neutral IP creation and configuration scripts (*generators*). The data and data access specification is designed to coexist and enhance the hardware description languages (HDLs) presently used by designers while providing capabilities lacking in those languages.

The SPIRIT Consortium is a consortium of electronic system, IP provider, semiconductor, and EDA companies. IP-XACT enables a productivity boost in design, transfer, validation, documentation, and use of electronic IP and covers components, designs, interfaces, and details thereof. The data specified by IP-XACT is extensible in locations specified in the schema.

IP-XACT enables the use of a unified structure for the meta specification of a design, components, interfaces, documentation, and interconnection of components. This structure can be used as the basis of both manual and automatic methodologies. IP-XACT specifies the tight generator interface (TGI) for access to the data in a vendor-independent manner.

This standardization project provides electronic design engineers with a well-defined standard that meets their requirements in structured design and validation, and enables a step function increase in their productivity. This standardization project will also provide the EDA industry with a standard to which they can adhere and that they can support in order to deliver their solutions in this area.

The SPIRIT Consortium has prepared a set of bus and abstraction definitions for several common buses. It is expected, over time, that those standards groups and manufacturers who define buses will include IP-XACT eXtensible Markup Language (XML) bus and abstraction definitions in their set of deliverables. Until that time, and to cover existing useful buses, a set of bus and abstraction definitions for common buses has been created.

A set of reference bus and abstraction definitions allows many vendors who define IP using these buses to easily interconnect IP together. The SPIRIT Consortium posts these for use by its members, with no warranty of suitability, but in the hope that these will be useful. The SPIRIT Consortium will, from time-to-time, update these files and if a Standards body wishes to take over the work of definition, will transfer that work to that body.

These reference bus and abstraction definition templates (with comments and examples) are available from the public area of The SPIRIT Consortium Web site.^a

^aAvailable at <http://www.spiritconsortium.org>.

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1.2 Purpose

This standard enables the creation and exchange of IP in a highly automated design environment.

1.3 Design environment

The IP-XACT specification is a mechanism to express and exchange information about design IP and its required configuration.² While the IP-XACT description formats are the core of this standard, describing the IP-XACT specification in the context of its basic use model, the design environment (DE), more readily depicts the extent and limitations of the semantic intent of the data. The DE coordinates a set of tools and IP, or expressions of that IP (e.g., models), through the creation and maintenance of meta-data descriptions of the system on chip (SoC) such that its system design and implementation flows are efficiently enabled and reuse centric.

The use of the IP-XACT specified formats and interfaces are shown, in **bold**, in [Figure 1](#) and described in the following subclauses.

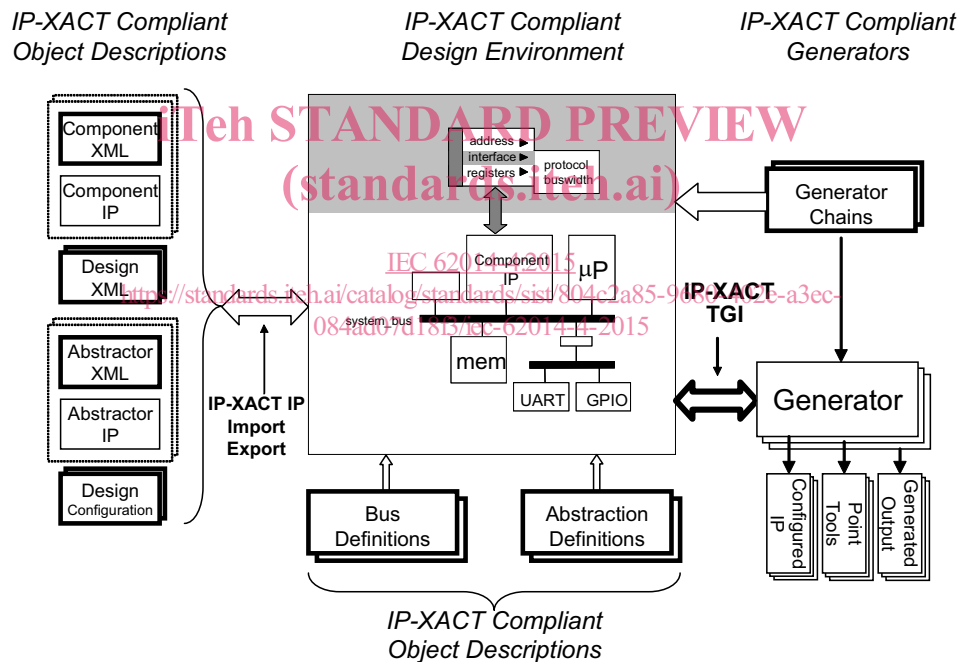


Figure 1—IP-XACT design environment

1.3.1 IP-XACT design environment

A DE enables the designer to work with IP-XACT design IP through a coordinated front-end and IP design database. These tools create and manage the top-level meta-description of system design and may provide two basic types of services: *design capture*, which is the expression of design configuration by the IP

²IP-XACT uses the World Wide Web Consortium (W3C[®]) standard for the XML version 1.0 data (<http://www.w3.org/TR/2000/REC-xml-20001006>). The valid format of that XML data is described in a *schema* by using the Schema Description Language described therein. W3C is a registered trademark of the World Wide Web Consortium.